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## WP201208-ATC3

# SMD Type White Emitter

#### Features

- Top view 0805 package
- Viewing Angle =  $\pm 60^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright White
- RoHS compliance

### **Applications**

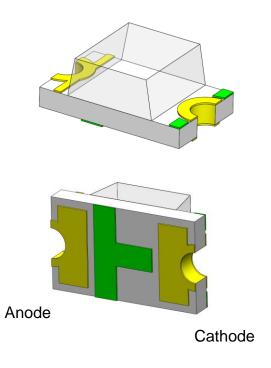
- Optical indicator.
- Switch and Symbol Display.

#### Description

The WP201208-ATC3 is an AllnGaN White LED housed in a miniature SMD package. Static electricity and surge damage the LEDs. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs

#### Package Outline

#### Schematic



Cathode node (-)



### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
IFP	Peak Forward Current	60	mA	1
VR	Reverse Voltage	5	V	
T <sub>opr</sub>	Operating Temperature	-40 ~ +85	0C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	0C	
T <sub>sol</sub>	Soldering Temperature	260	٥C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

#### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

#### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =20mA	565	-	1120	mcd	3
θ1/2	Angle of Half Intensity	I <sub>F</sub> =20mA	-	±60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =20mA	3.0	-	3.4	V	4
IR	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	

#### Notes:

- 1. IFP Conditions--Pulse Width  $\leq 100 \mu s$  and Duty  $\leq 10\%$ .
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
U2	565	715		
V1	715	900	mcd	I <sub>F</sub> =20mA
V2	900	1120		

Tolerance of: Luminous Intensity ±10%



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#### 4. Bin Range of Forward Voltage

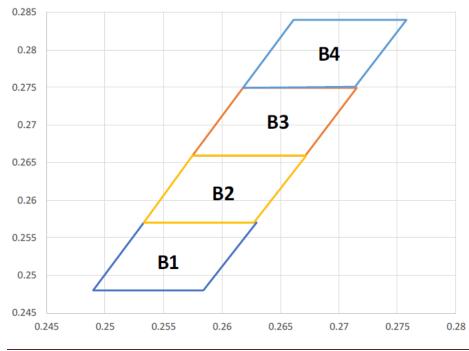
Bin Code	Min	Max	Unit	Condition
37	3.0	3.1		
38	3.1	3.2	V	L 20m A
39	3.2	3.3	v	I⊧=20mA
40	3.3	3.4		

Tolerance of Forward Voltage  $\pm 0.05$ V.

#### 5. Bin Range of Chromaticity Coordinates

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2490	0 0.2480	0.2533	0.2570	
B1	0.2533	0.2570	B2	0.2575	0.2660
ы	0.2630	0.2570	D2	0.2672	0.2660
	0.2584	0.2480		0.2627	0.2570
	0.2575	0.2618 0.2750		0.2618	0.2750
B3	0.2618		B4	0.2661	0.2840
БЗ	0.2715	0.2750	Б4	0.2758	0.2840
	0.2671	0.2660		0.2714	0.2751

#### The C.I.E 1931 Chromaticity Diagram



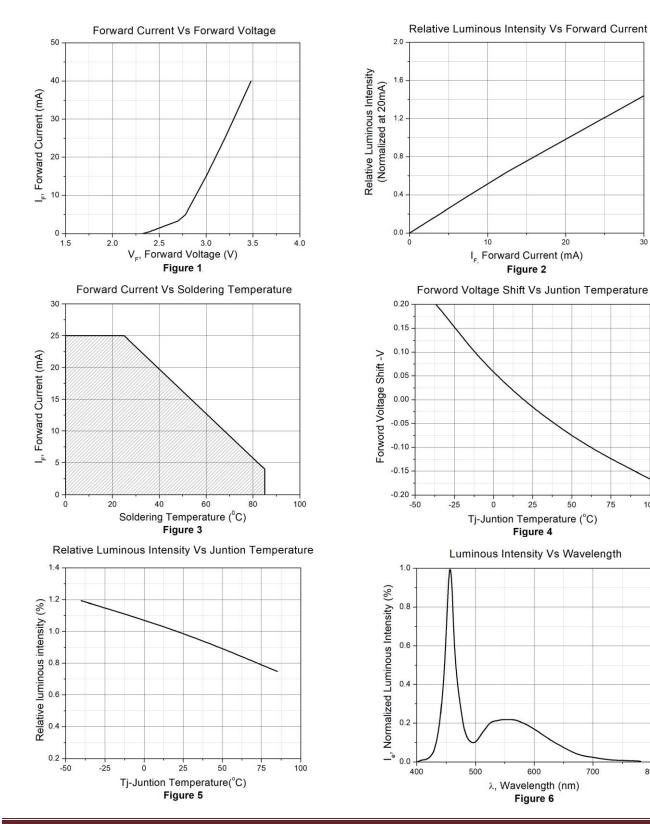


30

75

100

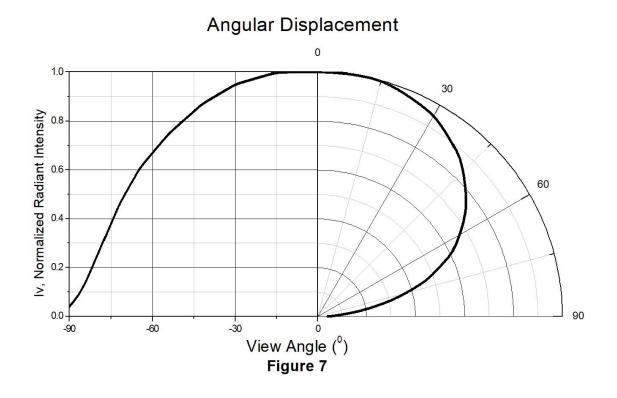
# **Typical Characteristic Curves**



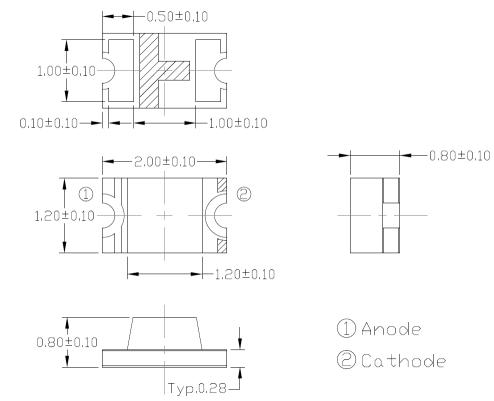
800



# **Typical Characteristic Curves**



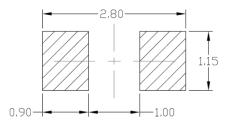




#### Package Dimension All dimensions are in mm, unless otherwise stated

Note: Tolerance unless mentioned is  $\pm 0.1$ mm.

## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



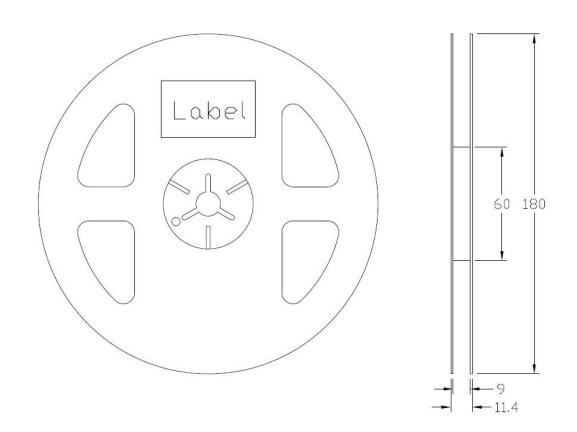
Note: Tolerance unless mentioned is  $\pm 0.1$ mm.

### **Ordering Information**

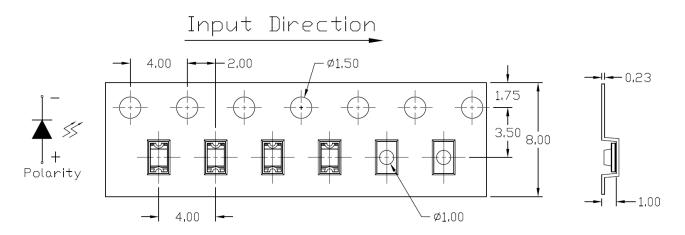
Part Number	Description	Quantity
WP201208-ATC3	Tape & Reel	3000 pcs



#### Reel Dimension All dimensions are in mm, unless otherwise stated



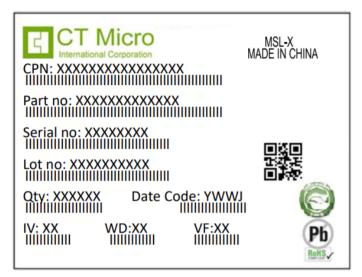
#### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



### Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

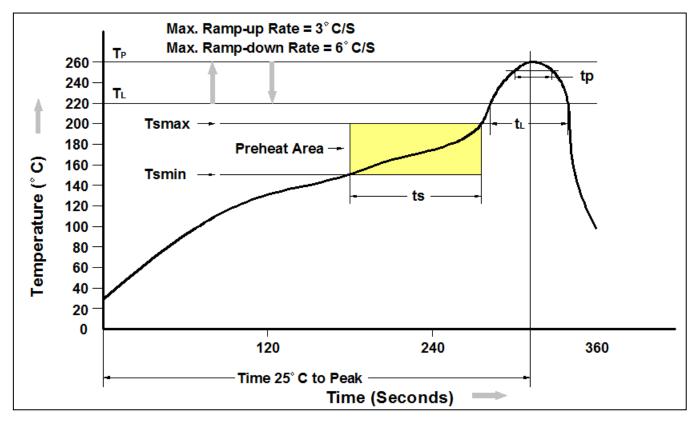
### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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